Datasheet



N-channel SiC power MOSFET

V_{DSS}	1200V
R _{DS(on)} (Typ.)	36mΩ
I _D *1	40A
P_{D}	150W

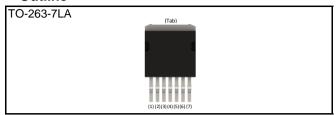
Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant
- 7) Wide creepage distance = min.4.7 mm

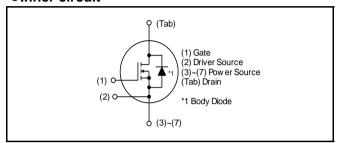
Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating

Outline



•Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

	Packing	Embossed tape		
	Reel size (mm)	330		
Typo	Tape width (mm)	24		
Type	Basic ordering unit (pcs)	1000		
	Taping code	TL		
	Marking	SCT4036KWA		

● **Absolute maximum ratings** (T_{vi} = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Drain - source voltage		V_{DSS}	1200	V	
Continuous drain	\/ -\/	$T_c = 25^{\circ}C$	I _D , I _S *1	40	А
and source current	$V_{GS} = V_{GS_on}$	T _c = 100°C	I _D , I _S	28	А
Pulsed drain current	$V_{GS} = V_{GS_on}$	$T_c = 25^{\circ}C$	I _{D,pulse} *2	84	А
Body diode pulsed forward	ard current	$T_c = 25^{\circ}C$	I _{S,pulse} *1,*3	40	А
Body diode surge forward current $V_{GS} = 0 \text{ V}$		$V_{GS} = 0 V$	I _{S,pulse} *1,*4	84	А
Gate - source voltage (DC)		V_{GSS_DC}	-4 to +21	V	
Gate - source surge voltage (t _{surge} < 300ns)		V _{GSS_surge} *5	-4 to +23	V	
Recommended turn-on gate - source drive voltage		$V_{GS_on}^{*6}$	+15 to +18	V	
Recommended turn-off gate - source drive voltage		V_{GS_off}	0	V	
Virtual junction temperature		T_{vj}	175	°C	
Range of storage temperature		T_{stg}	-40 to +175	°C	

ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Doromotor	Cymbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	W	$V_{GS} = 0 \text{ V}, I_D = 9.2 \text{mA}$				V
	V (BR)DSS	$T_{vj} = 25^{\circ}C$	1200	-	-	V
		$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{V}$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	80	μA
Diam carront		T _{vj} = 150°C	-	10	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V , V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current		$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}^{*7}$	$V_{DS} = 10V, I_{D} = 11.1 \text{mA}$	2.8	ı	4.8	V
		$V_{GS} = 18V, I_{D} = 21A$				
Static Drain - Source on - state resistance	R _{DS(on)} *8	$T_{vj} = 25^{\circ}C$	-	36	47	mΩ
		T _{vj} = 150°C	-	72	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	1	-	Ω

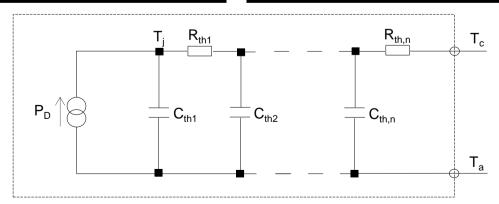
●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	R _{thJC} *9	-	0.79	1.0	K/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	5.1 × 10 ⁻²	
R _{th2}	3.6 ×10 ⁻¹	K/W
R _{th3}	3.8 ×10 ⁻¹	

Symbol	Value	Unit
C _{th1}	8.8 ×10 ⁻⁴	
C_{th2}	4.5 × 10 ⁻³	Ws/K
C _{th3}	1.3 ×10 ⁻¹	



ullet Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

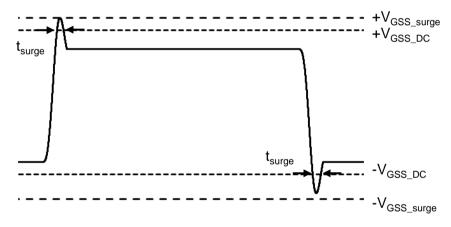
Davamatav	Cymaela al	Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	g _{fs} *8	$V_{DS} = 10V, I_{D} = 21A$	-	11	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	2335	-	
Output capacitance	C _{oss}	V _{DS} = 800V	-	70	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	5	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 800V$	-	84	-	pF
Total Gate charge	Q _g *8	$V_{DS} = 800V$ $I_{D} = 21A$	1	91	1	
Gate - Source charge	Q _{gs} *8	$V_{GS} = 18V$	ı	20	ı	nC
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	ı	24	1	
Turn - on delay time	t _{d(on)} *8	$V_{DS} = 800V$ $I_{D} = 21A$	ı	8.1	ı	
Rise time	t _r *8	$V_{GS} = +18V / 0V$	1	15	1	ns
Turn - off delay time	t _{d(off)} *8	$R_G = 3.3\Omega$, L = 250µH E_{on} includes diode	ı	29	ı	115
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50 \text{nH}, C_{\sigma} = 10 \text{pF}$	1	9.6	1	
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	239	-	μJ
Turn - off switching loss	E _{off} *8		ı	26	ı	μυ
$V_{GS(on)} = +15V$ Short-circuit	. t _{sc} *10	V _{DS} ≤ 800V V _{DS,peak} ≤ 1200V	-	4.5	-	μs
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_G = 2.2\Omega$	-	4.0	-	μs

●Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Dorometer	Symbol	ool Conditions	Values			l lmit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V _{SD} *8	$V_{GS} = 0V, I_{S} = 21A$	ı	3.3	ı	V
Reverse recovery time	t _{rr} *8	$I_F = 21A$ $V_R = 800V$	ı	9.2	ı	ns
Reverse recovery charge	Q _{rr} *8	di/dt = 3700A/µs	ı	140	ı	nC
Peak reverse recovery current	I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	31	1	А

^{*1} Limited by maximum T_{vj} and for Max. R_{thJC} .

*5 Example of acceptable V_{GS} waveform



- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying $V_{GS} = 21V$ for 100ms.
- *8 Pulsed
- *9 Measured conformable to JESD51-14.

See the application note "rthjc_measurement_and_usage_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc_measurement_and_usage_an-e.pdf

*10 The value is based on TO-247 package. Single Pulsed.

^{*2} Pulse width and duty cycle are limited by $T_{v_j,max}$.

^{*3} Only for body-diode, Repititive pulse, PW ≤ 1.5µs, Duty cycle ≤ 5%

^{*4} When used as a protective function, PW \leq 10 μ s

Fig.1 Power Dissipation Derating Curve

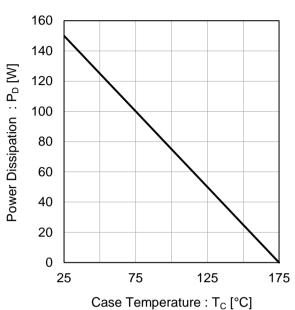


Fig.2 Maximum Safe Operating Area

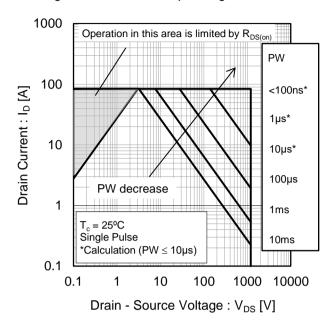
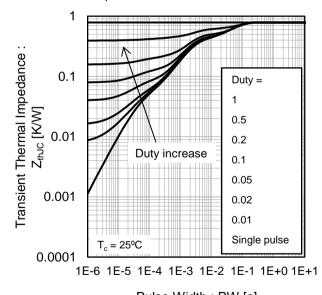


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width



Pulse Width: PW [s]

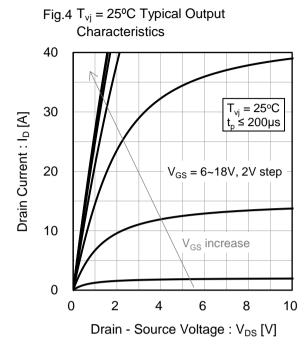
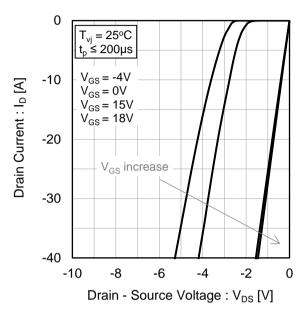
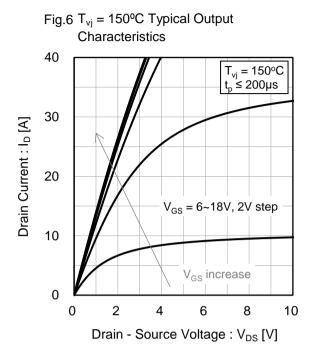


Fig.5 $T_{vj} = 25^{\circ}C$ 3rd Quadrant Characteristics



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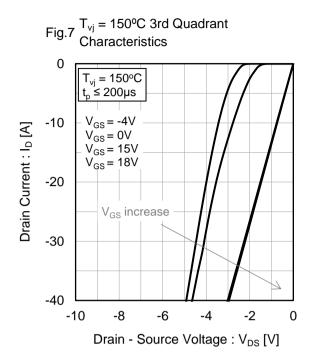


Fig.8 Body Diode Forward Voltage vs. Gate - Source Voltage

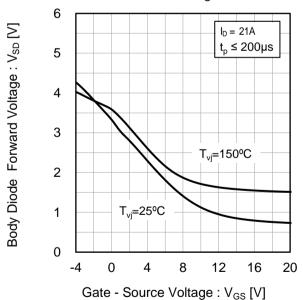


Fig.9 Typical Transfer Characteristics (I)

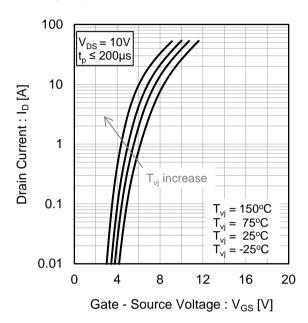


Fig.10 Typical Transfer Characteristics (II)

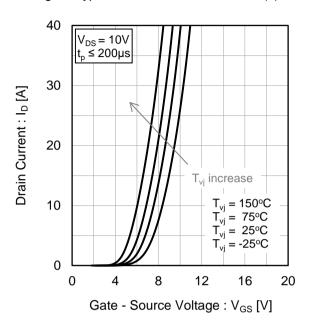


Fig.11 Gate Threshold Voltage vs. Virtual Junction Temperature

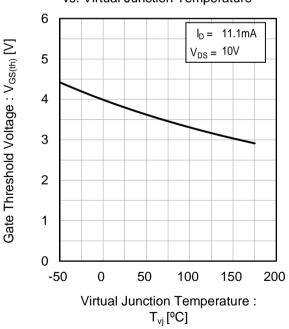
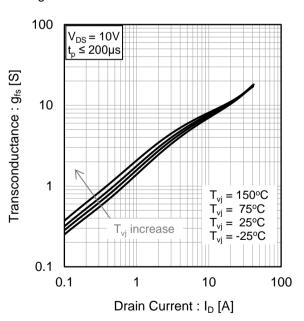
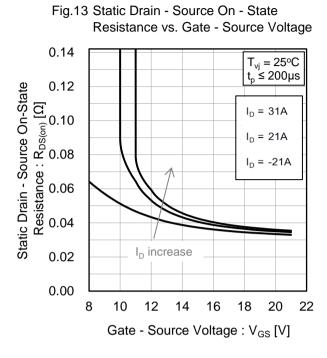


Fig.12 Transconductance vs. Drain Current





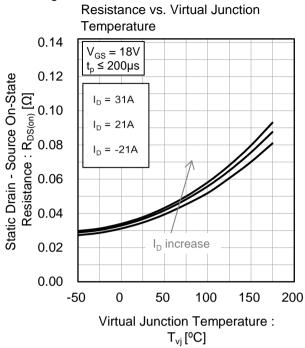
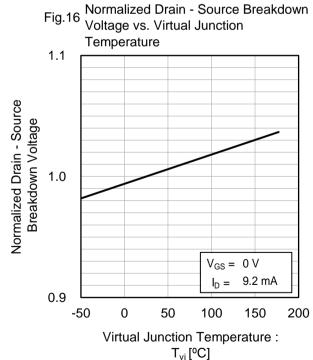
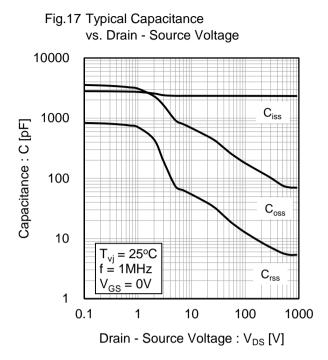


Fig.14 Static Drain - Source On - State

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current = 150°C = 125°C Static Drain - Source On-State $T_{vj} = 75^{\circ}C$ = 25°C Resistance: R_{DS(on)} [Ω] = -25°C 0.1 0.01 T_{vi} increase $V_{GS} = 18V$ $t_p \le 200 \mu s$ 0.001 10 100 Drain Current: I_D [A]



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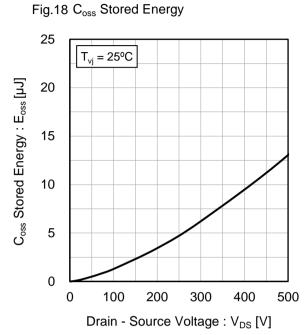


Fig.19 Dynamic Input Characteristics

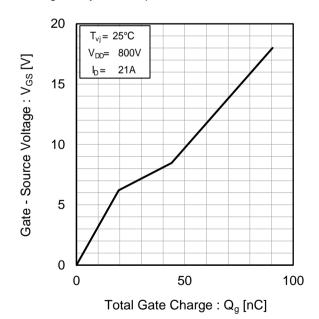
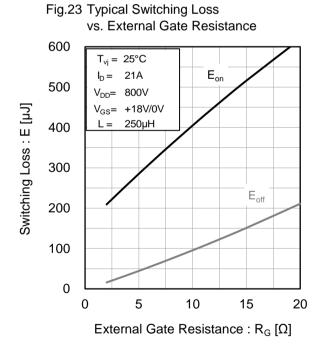


Fig.20 Typical Switching Time vs. External Gate Resistance 120 $T_{vj} = 25^{\circ}C$ 21A 100 $t_{\text{d}(\underline{\text{off})}}$ V_{DD}= 800V V_{GS}= +18V/0V Switching Time : t [ns] $L = 250 \mu H$ 80 60 $t_{d(on)}$ 40 20 t_{f} 0 5 0 10 15 20 External Gate Resistance : $R_G[\Omega]$

vs. Drain - Source Voltage 600 $T_{vj} = 25^{\circ}C$ $I_D = 21A$ 500 $V_{GS} = +18 V/0 V$ Switching Loss: E [µJ] $R_G = 3.3\Omega$ 400 $L = 250 \mu H$ 300 E_{on} 200 100 0 100 200 300 400 500 600 700 800 Drain - Source Voltage: V_{DS} [V]

Fig.21 Typical Switching Loss

Fig.22 Typical Switching Loss vs. Drain Current 600 $T_{vj} = 25^{\circ}C$ V_{DD}= 800V 500 V_{GS}= +18V/0V Switching Loss : E [µJ] $R_G = 3.3\Omega$ 400 250µH E_{on} 300 200 $\mathsf{E}_{\mathrm{off}}$ 100 0 0 5 15 20 25 10 35 40 Drain Current: I_D [A]



Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

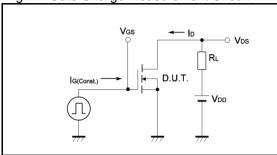


Fig.2-1 Switching Characteristics Measurement Circuit

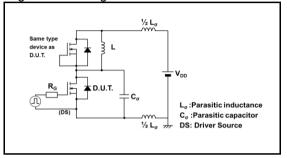


Fig.2-3 Waveforms for Switching Energy Loss

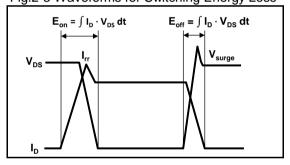


Fig.3-1 Reverse Recovery Time Measurement Circuit

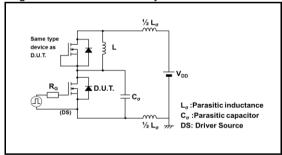


Fig.1-2 Gate Charge Waveform

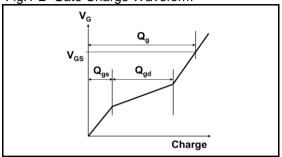


Fig.2-2 Waveforms for Switching Time

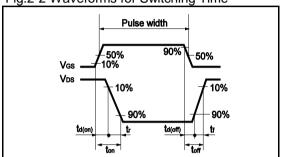
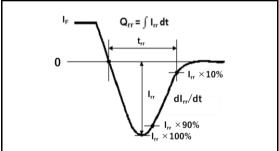
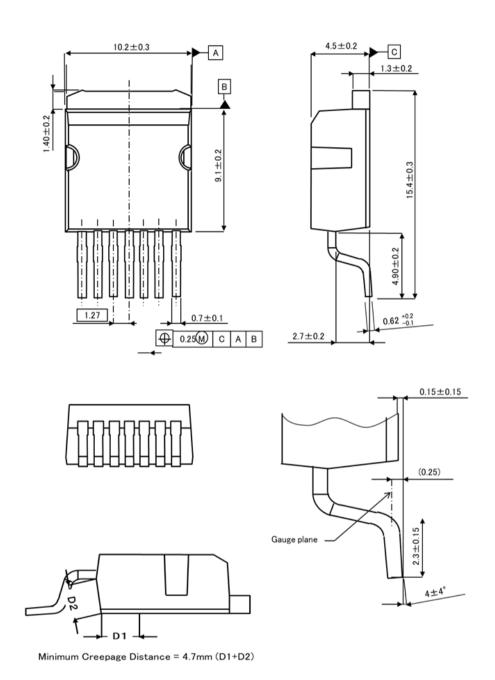


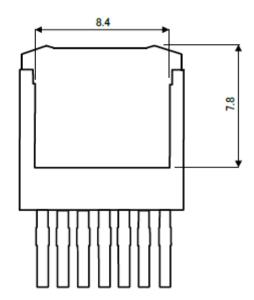
Fig.3-2 Reverse Recovery Waveform



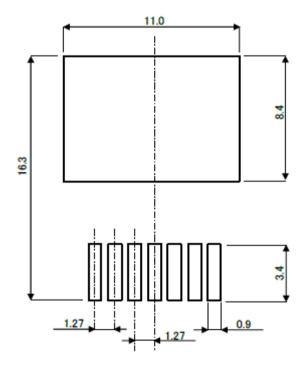
●Package Dimensions



Unit: mm

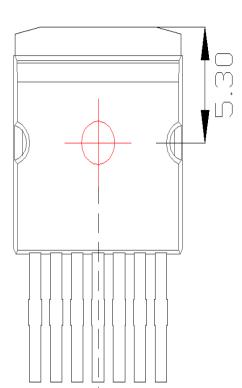


RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm

●Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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